

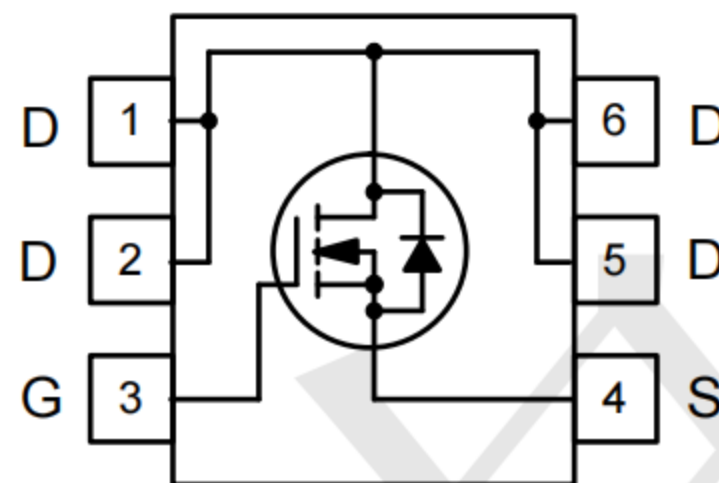
### Features

- $V_{DS} = 200V$
- $I_D = 1.5A$
- $R_{DS(ON)} \leq 0.7\Omega @ V_{GS} = 10V$

### Application

- Load/Power Switching
- Interfacing Switching
- Battery Management for Ultra Small Portable Electronics
- Logic Level Shift

### Package and Pin Configuration



### Marking:262P

### Absolute Maximum Ratings ( $T_A=25^\circ C$ unless otherwise noted)

Characteristics	Symbol	Rating	Unit
Drain-Source Voltage	$V_{DSS}$	200	V
Gate-Source Voltage	$V_{GSS}$	$\pm 20$	V
Continuous Drain Current	$I_D$	1.5	A
Pulsed Drain Current <sup>(1)</sup>	$I_{DM}$	4.5	A
Power Dissipation	$P_d$	1.6	W
Junction and Storage Temperature Range	$T_J, T_{stg}$	-55~150	$^\circ C$

### Thermal Characteristics

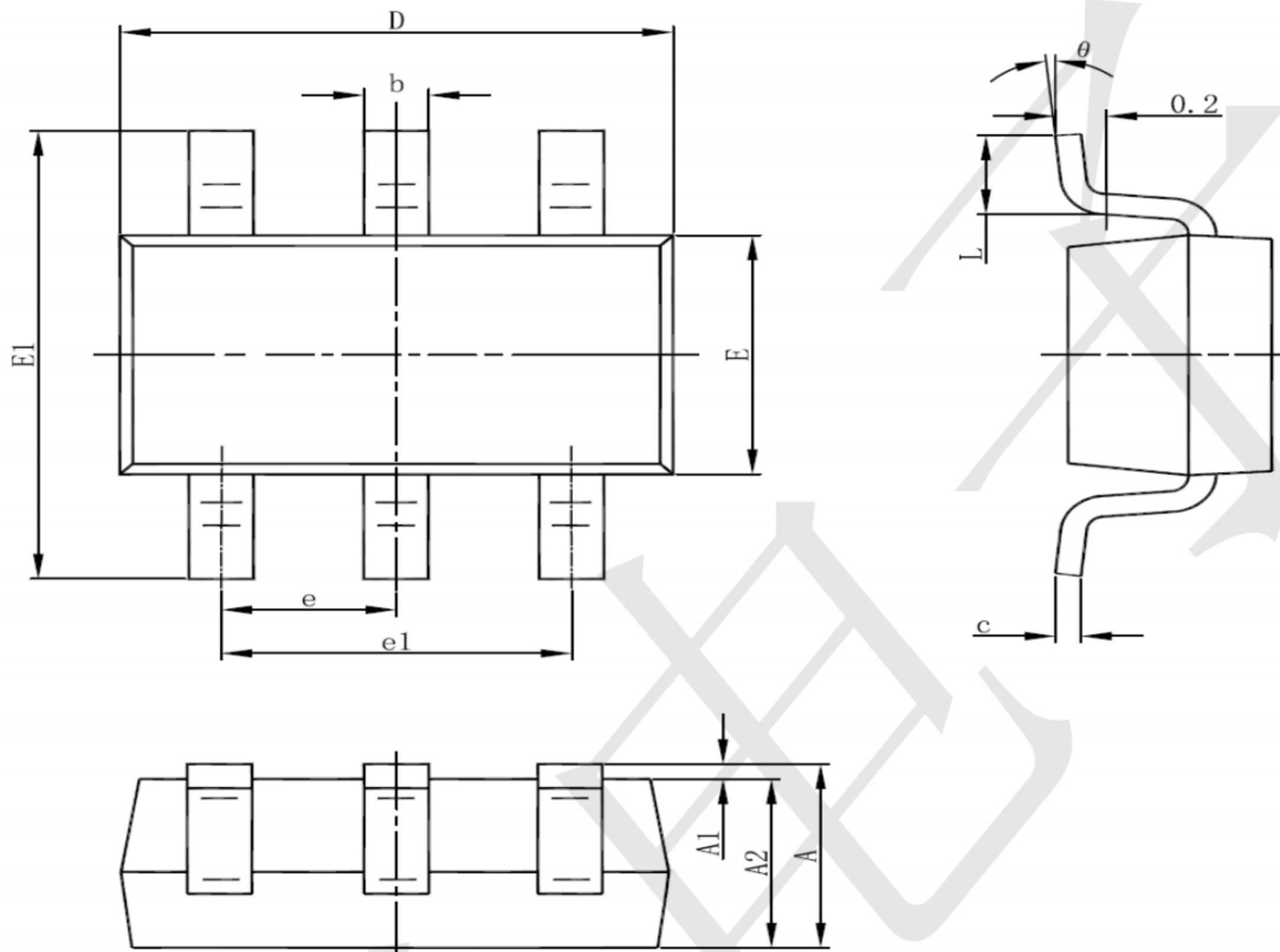
Characteristics	Symbol	Rating	Unit
Thermal Resistance, Junction-to-Ambient <sup>(1)</sup>	$R_{\theta JA}$	90	$^\circ C/W$
Thermal Resistance, Junction-to-Case <sup>(1)</sup>	$R_{\theta JC}$	30	

**Electrical Characteristics ( $T_A=25^{\circ}\text{C}$  unless otherwise noted)**

Characteristics	Symbol	Test Condition	Min	Typ	Max	Unit
<b>Static Characteristics</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$I_D = 250\mu\text{A}, V_{GS} = 0\text{V}$	200	-	-	V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	2.0	3.0	4.0	
Drain Cut-Off Current	$I_{DSS}$	$V_{DS} = 160\text{V}, V_{GS} = 0\text{V}$	-	-	1	$\mu\text{A}$
Gate Leakage Current	$I_{GSS}$	$V_{GS} = \pm 20\text{V}, V_{DS} = 0\text{V}$	-	-	100	nA
Drain-Source ON Resistance	$R_{DS(on)}$	$V_{GS} = 10\text{V}, I_D = 1.0\text{A}$	-	0.55	0.7	$\Omega$
Forward Transconductance	$g_{fs}$	$V_{DS} = 10\text{V}, I_D = 1.0\text{A}$	-	4.0	-	S
<b>Dynamic Characteristics</b>						
Total Gate Charge	$Q_g$	$V_{DS} = 100\text{V}, V_{GS} = 10\text{V}, I_D = 1.0\text{A}$	-	5.1	-	nC
Gate-Source Charge	$Q_{gs}$		-	1.5	-	
Gate-Drain Charge	$Q_{gd}$		-	2.0	-	
Input Capacitance	$C_{iss}$	$V_{DS} = 100\text{V}, V_{GS} = 0\text{V}, f = 1\text{MHz}$	-	220	-	pF
Reverse Transfer Capacitance	$C_{rss}$		-	5.6	-	
Output Capacitance	$C_{oss}$		-	46.9	-	
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = 100\text{V}, I_D = 1\text{A}, V_{GS} = 10\text{V}, R_{GEN} = 6\Omega$	-	6.3	-	ns
Rise Time	$t_r$		-	6.3	-	
Turn-Off Delay Time	$t_{d(off)}$		-	19.5	-	
Fall Time	$t_f$		-	10.7	-	
<b>Drain-Source Body Diode Characteristics</b>						
Maximum Continuous Drain to Source Diode Forward Current	$I_S$		-	1.5	-	A
Source-Drain Diode Forward Voltage	$V_{SD}$	$I_S = 1.5\text{A}, V_{GS} = 0\text{V}$	-	-	1.4	V
Body Diode Reverse Recovery Time	$t_{rr}$	$I_F = 1.3\text{A}, di/dt = 100\text{A}/\mu\text{s}$	-	81	-	ns
Body Diode Reverse Recovery Charge	$Q_{rr}$		-	0.25	-	$\mu\text{C}$



SOT23-6 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950(BSC)		0.037(BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°